


- ART01 = LAYER 1 (COMPONENT SIDE)
- ART02 = LAYER 2 (TRACE)
- ART03 = LAYER 3 (GND)
- ART04 = LAYER 4 (SOLDER SIDE)

NOTES : Unless Otherwise Specified

- 1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD
THICKNESS .062 +/--.006 TOTAL OF 4 LAYERS
- 2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE
ELECTRODEPOSITED TIN-LEAD COMPOSITION
BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SMOBC)
- 3. SOLDER MASK : BOTH SIDES USING LPI OR EQUIVALENT
- 4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK
- 5. ALL DIMENSIONS ARE IN INCHES

Fabrication Drawing

APPROVALS		 LINEAR TECHNOLOGY 1630 McCarthy Blvd. Milpitas, CA 95035 PH: (408)432-1900	
DRAWN	INIT	DATE	
CHECK			
DESIGN	KML		
ENGR			
TITLE:		Low Cost VRM For Mobile Computing	
SIZE	DEMO BRD	REV.	A
SCALE = NONE		DES- 0000	
		SHT 1 of 1	